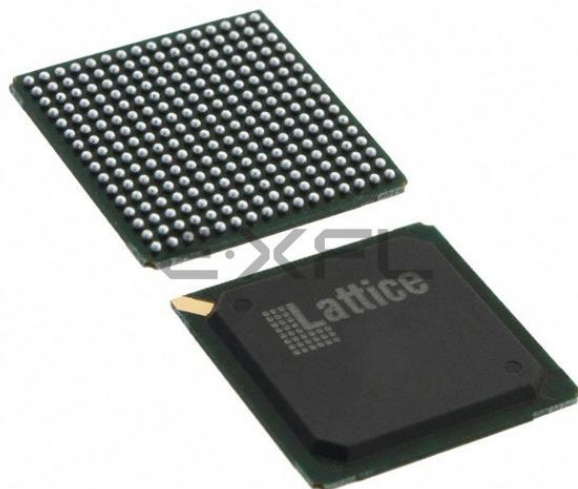




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Understanding [Embedded - FPGAs \(Field Programmable Gate Array\)](#)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details

Product Status	Obsolete
Number of LABs/CLBs	1500
Number of Logic Elements/Cells	12000
Total RAM Bits	226304
Number of I/O	193
Number of Gates	-
Voltage - Supply	1.14V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	256-BGA
Supplier Device Package	256-FPBGA (17x17)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfe2-12e-6f256c

Figure 2-1. Simplified Block Diagram, ECP2-6 Device (Top Level)

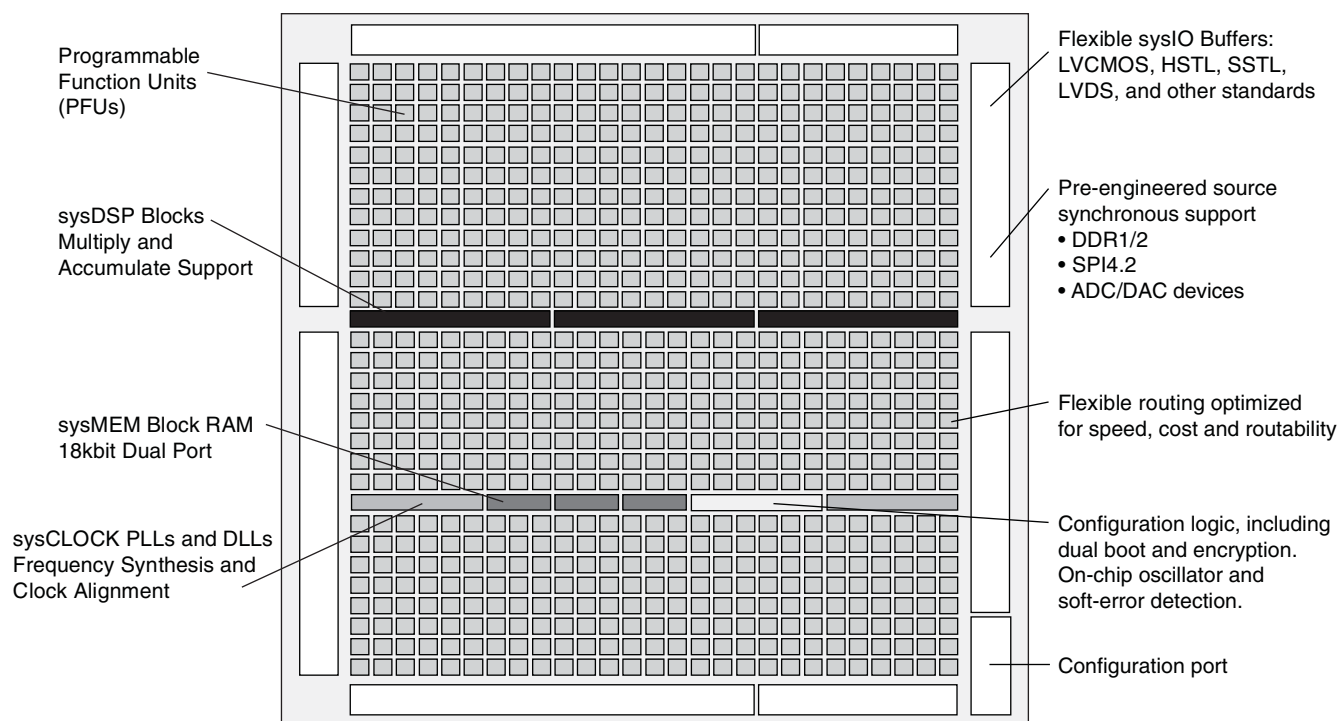
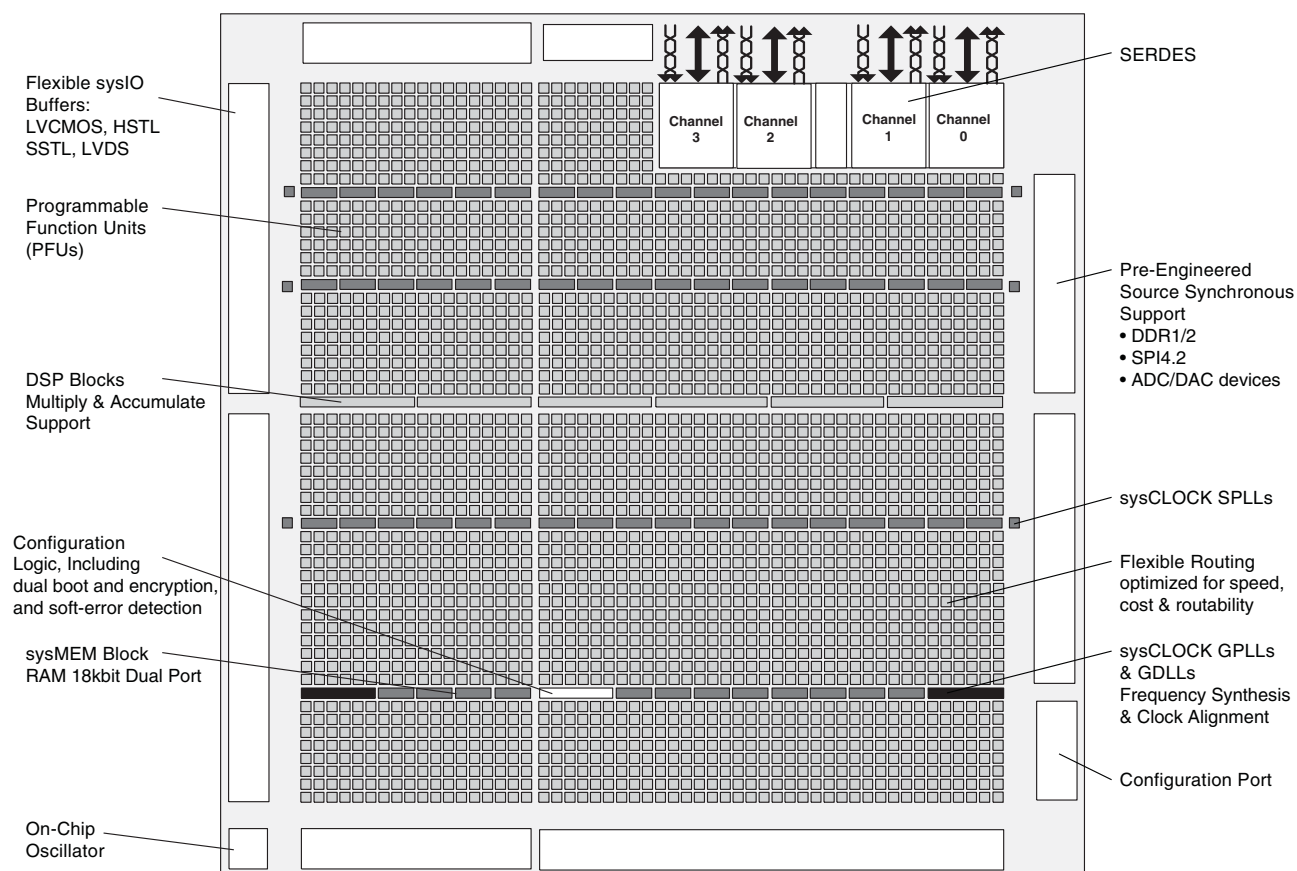


Figure 2-2. Simplified Block Diagram, ECP2M20 Device (Top Level)



IPexpress™

The user can access the sysDSP block via the IPexpress tool, which provides the option to configure each DSP module (or group of modules) or by direct HDL instantiation. In addition, Lattice has partnered with The MathWorks® to support instantiation in the Simulink® tool, a graphical simulation environment. Simulink works with Diamond to dramatically shorten the DSP design cycle in Lattice FPGAs.

Optimized DSP Functions

Lattice provides a library of optimized DSP IP functions. Some of the IP cores planned for the LatticeECP2/M DSP include the Bit Correlator, Fast Fourier Transform, Finite Impulse Response (FIR) Filter, Reed-Solomon Encoder/Decoder, Turbo Encoder/Decoder and Convolutional Encoder/Decoder. Please contact Lattice to obtain the latest list of available DSP IP cores.

Resources Available in the LatticeECP2/M Family

Table 2-9 shows the maximum number of multipliers for each member of the LatticeECP2/M family. Table 2-10 shows the maximum available EBR RAM Blocks in each LatticeECP2/M device. EBR blocks, together with Distributed RAM can be used to store variables locally for fast DSP operations.

Table 2-9. Maximum Number of DSP Blocks in the LatticeECP2/M Family

Device	DSP Block	9x9 Multiplier	18x18 Multiplier	36x36 Multiplier
ECP2-6	3	24	12	3
ECP2-12	6	48	24	6
ECP2-20	7	56	28	7
ECP2-35	8	64	32	8
ECP2-50	18	144	72	18
ECP2-70	22	176	88	22
ECP2M20	6	48	24	6
ECP2M35	8	64	32	8
ECP2M50	22	176	88	22
ECP2M70	24	192	96	24
ECP2M100	42	336	168	42

Table 2-10. Embedded SRAM in the LatticeECP2/M Family

Device	EBR SRAM Block	Total EBR SRAM (Kbits)
ECP2-6	3	55
ECP2-12	12	221
ECP2-20	15	277
ECP2-35	18	332
ECP2-50	21	387
ECP2-70	60	1106
ECP2M20	66	1217
ECP2M35	114	2101
ECP2M50	225	4147
ECP2M70	246	4534
ECP2M100	288	5308

Figure 2-31. Output and Tristate Block for Left, Right and Bottom Edges

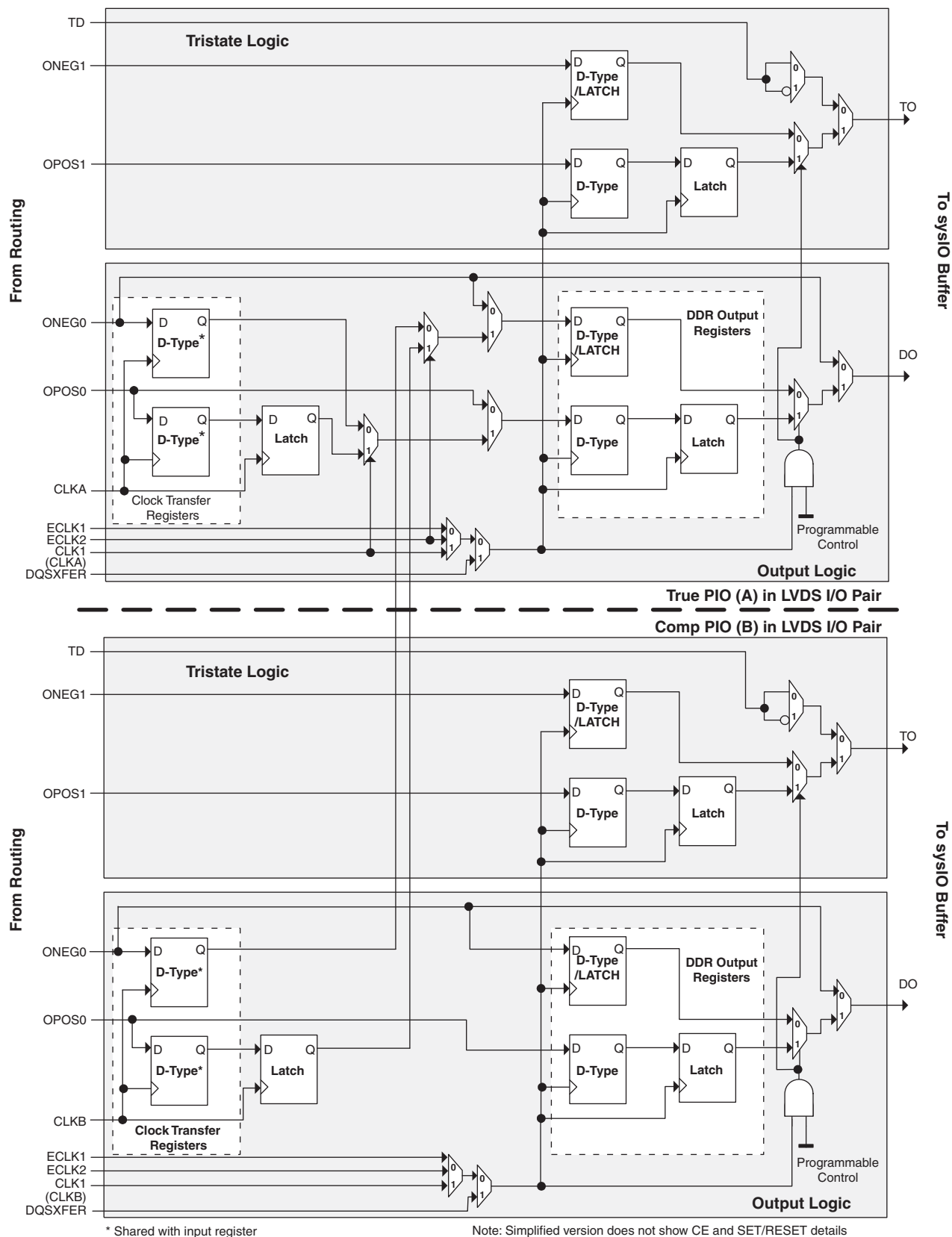
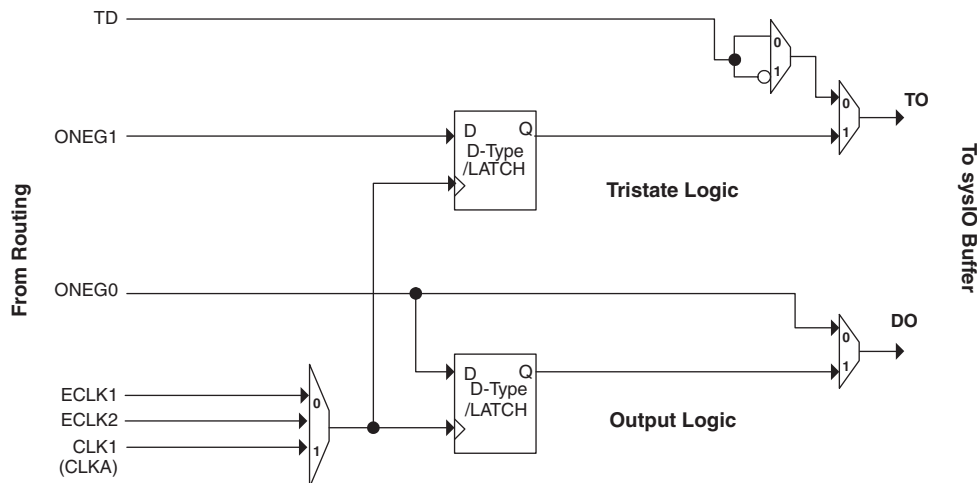


Figure 2-32. Output and Tristate Block, Top Edge



Note: Simplified version does not show CE and SET/RESET details.

Tristate Register Block

The tristate register block provides the ability to register tri-state control signals from the core of the device before they are passed to the sysI/O buffers. The block contains a register for SDR operation and an additional latch for DDR operation. Figure 2-31 shows the diagram of the Tristate Register Block with the Output Block for the left, right and bottom edges and Figure 2-32 shows the diagram of the Tristate Register Block with the Output Block for the top edge.

In SDR mode, ONEG1 feeds one of the flip-flops that then feeds the output. The flip-flop can be configured a D-type or latch. In DDR mode, ONEG1 and OPOS1 are fed into registers on the positive edge of the clock. Then in the next clock the registered OPOS1 is latched. A multiplexer running off the same clock cycle selects the correct register for feeding to the output (DO).

Control Logic Block

The control logic block allows the selection and modification of control signals for use in the PIO block. A clock is selected from one of the clock signals provided from the general purpose routing, one of the edge clocks (ECLK1/ ECLK2) and a DQS signal provided from the programmable DQS pin and provided to the input register block. The clock can optionally be inverted.

DDR Memory Support

Certain PICs have additional circuitry to allow the implementation of high speed source synchronous and DDR memory interfaces. The support varies by the edge of the device as detailed below.

Left and Right Edges

PICs on these edges have registered elements that support DDR memory interfaces. One of every 16 PIOs contains a delay element to facilitate the generation of DQS signals. The DQS signal feeds the DQS bus that spans the set of 16 PIOs. Figure 2-33 shows the assignment of DQS pins in each set of 16 PIOs.

Bottom Edge

PICs on the bottom edge have registered elements that support DDR memory interfaces. One of every 18 PIOs contains a delay element to facilitate the generation of DQS signals. The DQS signal feeds the DQS bus that spans the set of 18 PIOs. Figure 2-34 shows the assignment of DQS pins in each set of 18 PIOs.

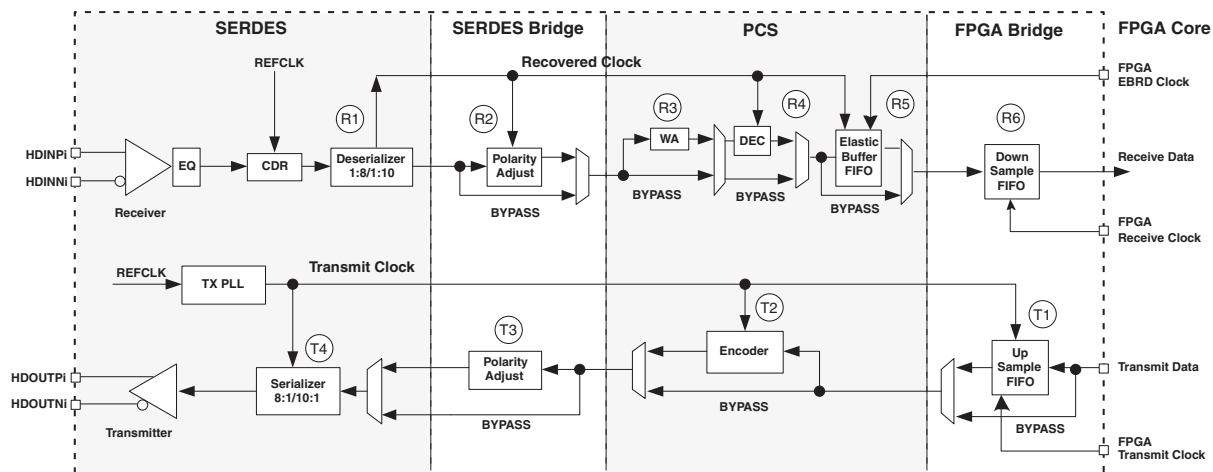
DC Electrical Characteristics

Over Recommended Operating Conditions

Symbol	Parameter	Condition	Min.	Typ.	Max.	Units
$I_{IL}, I_{IH}^{1,2}$	Input or I/O Low Leakage	$0 \leq V_{IN} \leq (V_{CCIO} - 0.2V)$	—	—	10	μA
$I_{IH}^{1,3}$	Input or I/O High Leakage	$(V_{CCIO} - 0.2V) < V_{IN} \leq 3.6V$	—	—	150	μA
I_{PU}	I/O Active Pull-up Current	$0 \leq V_{IN} \leq 0.7 V_{CCIO}$	-30	—	-210	μA
I_{PD}	I/O Active Pull-down Current	$V_{IL} (MAX) \leq V_{IN} \leq V_{IH} (MAX)$	30	—	210	μA
I_{BHLS}	Bus Hold Low Sustaining Current	$V_{IN} = V_{IL} (MAX)$	30	—	—	μA
I_{BHHS}	Bus Hold High Sustaining Current	$V_{IN} = 0.7 V_{CCIO}$	-30	—	—	μA
I_{BHLO}	Bus Hold Low Overdrive Current	$0 \leq V_{IN} \leq V_{CCIO}$	—	—	210	μA
I_{BHHO}	Bus Hold High Overdrive Current	$0 \leq V_{IN} \leq V_{CCIO}$	—	—	-210	μA
V_{BHT}	Bus Hold Trip Points	$0 \leq V_{IN} \leq V_{IH} (MAX)$	$V_{IL} (MAX)$	—	$V_{IH} (MIN)$	V
$C1^4$	I/O Capacitance	$V_{CCIO} = 3.3V, 2.5V, 1.8V, 1.5V, 1.2V,$ $V_{CC} = 1.2V, V_{IO} = 0 \text{ to } V_{IH} (MAX)$	—	5	8	pf
$C2^4$	Dedicated Input Capacitance	$V_{CCIO} = 3.3V, 2.5V, 1.8V, 1.5V, 1.2V,$ $V_{CC} = 1.2V, V_{IO} = 0 \text{ to } V_{IH} (MAX)$	—	5	6	pf

1. Input or I/O leakage current is measured with the pin configured as an input or as an I/O with the output driver tri-stated. It is not measured with the output driver active. Bus maintenance circuits are disabled.
2. When used as V_{REF} maximum leakage = 25 μA
3. Applicable to general purpose I/Os in top and bottom banks.
4. T_A 25°C, $f = 1.0MHz$.

Figure 3-12. Transmitter and Receiver Block Diagram



LatticeECP2M Power Supply and NC (Cont.)

Signal	672 fpBGA	900 fpBGA
V _{CC}	LFE2M35: AD13, AD14, AD16, AD17, AD19, AD21, AD22, AD24, AD25, L12, L13, L14, L15, M11, M12, M15, M16, N11, N16, P11, P16, R11, R12, R15, R16, T12, T13, T14, T15 LFE2M50: L12, L13, L14, L15, M11, M12, M15, M16, N11, N16, P11, P16, R11, R12, R15, R16, T12, T13, T14, T15	LFE2M50: AH1, AH4, AH5, AH2, AH7, AH12, AH9, AH10, AH13, C13, C10, C9, C12, C7, C2, C5, C4, C1, L12, L13, L18, L19, M11, M12, M13, M14, M15, M16, M17, M18, M19, M20, N11, N12, N19, N20, P12, P19, R12, R19, T12, T19, U12, U19, V11, V12, V19, V20, W11, W12, W13, W14, W15, W16, W17, W18, W19, W20, Y12, Y13, Y18, Y19 LFE2M70/LFE2M100: L12, L13, L18, L19, M11, M12, M13, M14, M15, M16, M17, M18, M19, M20, N11, N12, N19, N20, P12, P19, R12, R19, T12, T19, U12, U19, V11, V12, V19, V20, W11, W12, W13, W14, W15, W16, W17, W18, W19, W20, Y12, Y13, Y18, Y19
V _{CCIO0}	B12, B7, F11, J13, K12	D14, E6, E9, F12, K12, K13
V _{CCIO1}	D18, F16, J14, K15	D17, E22, E25, F19, K18, K19
V _{CCIO2}	G25, L21, M17, M25, N18	F28, J25, K28, M21, M24, N21, N28, P21, R25
V _{CCIO3}	P18, R17, R25, T21, Y25	AA28, AB25, AE28, T25, U21, V21, V28, W21, W24
V _{CCIO4}	AA16, AC18, U15, V14	AA18, AA19, AE19, AF22, AG17, AG25
V _{CCIO5}	AA11, AE12, AE7, U12, V13	AA12, AA13, AE12, AF9, AG14, AG6
V _{CCIO6}	P9, R10, R2, T6, Y2	AA3, AB6, AE3, T6, U10, V10, V3, W10, W7
V _{CCIO7}	G2, L6, M10, M2, N9	F3, J6, K3, M10, M7, N10, N3, P10, R6
V _{CCIO8}	AC24, U17	AA25, AD28
V _{CCJ}	AA7	AG1
V _{CCAUX}	LFE2M35: AE19, J11, J12, J15, J16, L18, L9, M18, M9, R18, R9, T18, T9, V11, V12, V15, V16 LFE2M50: J11, J12, J15, J16, L18, L9, M18, M9, R18, R9, T18, T9, V11, V12, V15, V16	LFE2M50: AJ7, B7, AA10, AA11, AA20, AA21, K10, K11, K20, K21, L10, L11, L20, L21, Y10, Y11, Y20, Y21 LFE2M70/LFE2M100: AA10, AA11, AA20, AA21, K10, K11, K20, K21, L10, L11, L20, L21, Y10, Y11, Y20, Y21
V _{CCPLL}	H7, K6, P7, R8, V18, P20, J17, G19	N13, N18, V13, V18
SERDES Power ³	LFE2M35: C25, B25, C22, A22, C21, C20, C24, C23, B19, C19, C15, C14, C18, C17, A16, C16, B13, C13 LFE2M50: AD13, AE13, AD16, AF16, AD17, AD18, AD14, AD15, AD19, AE19, AD23, AD24, AD20, AD21, AF22, AD22, AE25, AD25, C25, B25, C22, A22, C21, C20, C24, C23, B19, C19, C15, C14, C18, C17, A16, C16, B13, C13	LFE2M50: AH18, AJ18, AH21, AK21, AH22, AH23, AH19, AH20, AH24, AJ24, AH28, AH29, AH25, AH26, AK27, AH27, AJ30, AH30, C30, B30, C27, A27, C26, C25, C29, C28, B24, C24, C20, C19, C23, C22, A21, C21, B18, C18 LFE2M70/LFE2M100: C13, B13, C10, A10, C9, C8, C12, C11, B7, C7, C3, C2, C6, C5, A4, C4, B1, C1, C30, B30, C27, A27, C26, C25, C29, C28, B24, C24, C20, C19, C23, C22, A21, C21, B18, C18, AH18, AJ18, AH21, AK21, AH22, AH23, AH19, AH20, AH24, AJ24, AH28, AH29, AH25, AH26, AK27, AH27, AJ30, AH30, AH1, AJ1, AH4, AK4, AH5, AH6, AH2, AH3, AH7, AJ7, AH11, AH12, AH8, AH9, AK10, AH10, AJ13, AH13

LatticeECP2M Power Supply and NC (Cont.)

Signal	672 fpBGA	900 fpBGA
GND ¹	A13, A19, A2, A25, AA2, AA25, AB18, AB22, AB5, AB9, AE1, AE11, AE16, AE22, AE26, AE6, AF13, AF19, AF2, AF25, B1, B11, B16, B22, B26, B6, E18, E22, E5, E9, F2, F25, G11, G16, J22, J5, K11, K13, K14, K16, L10, L11, L16, L17, L2, L20, L25, L7, M13, M14, N10, N12, N13, N14, N15, N17, P10, P12, P13, P14, P15, P17, R13, R14, T10, T11, T16, T17, T2, T20, T25, T7, U11, U13, U14, U16, V22, V5, Y11, Y16	LFE2M50: A1, A13, A18, A24, A30, A7, AA14, AA15, AA16, AA17, AA24, AA27, AA4, AB24, AB7, AD12, AD19, AD27, AE22, AE27, AE4, AE9, AF14, AF17, AF25, AF6, AJ10, AJ21, AJ27, AJ4, AK1, AK13, AK18, AK24, AK30, AK7, B10, B21, B27, B4, D25, D6, E14, E17, F22, F27, F4, F9, G12, G19, J24, J7, K14, K15, K16, K17, K27, K4, L14, L15, L16, L17, M23, M8, N14, N15, N16, N17, N27, N4, P11, P13, P14, P15, P16, P17, P18, P20, R10, R11, R13, R14, R15, R16, R17, R18, R20, R21, R24, R7, T10, T11, T13, T14, T15, T16, T17, T18, T20, T21, T24, T7, U11, U13, U14, U15, U16, U17, U18, U20, V14, V15, V16, V17, V27, V4, W23, W8, Y14, Y15, Y16, Y17 LFE2M70/LFE2M100: A1, A13, A18, A24, A30, A7, AA14, AA15, AA16, AA17, AA24, AA27, AA4, AB24, AB7, AD12, AD19, AD27, AE22, AE27, AE4, AE9, AF14, AF17, AF25, AF6, AJ10, AJ21, AJ27, AJ4, AK1, AK13, AK18, AK24, AK30, AK7, B10, B21, B27, B4, D25, D6, E14, E17, F22, F27, F4, F9, G12, G19, J24, J7, K14, K15, K16, K17, K27, K4, L14, L15, L16, L17, M23, M8, N14, N15, N16, N17, N27, N4, P11, P13, P14, P15, P16, P17, P18, P20, R10, R11, R13, R14, R15, R16, R17, R18, R20, R21, R24, R7, T10, T11, T13, T14, T15, T16, T17, T18, T20, T21, T24, T7, U11, U13, U14, U15, U16, U17, U18, U20, V14, V15, V16, V17, V27, V4, W23, W8, Y14, Y15, Y16, Y17
NC ²	LFE2M35: AB3, AB4, AC1, AC2, AD15, AD18, AD20, AD23, AE13, AE25, AF16, AF22, B4, B5, C26, D20, D21, D22, D23, D24, D25, D26, E20, E21, E25, E26, F20, G20, K10, K17, R4, U10, U23, V10, W7, N7, V7 LFE2M50: AB3, AB4, AC1, AC2, B4, B5, C26, D20, D21, D22, D23, D24, D25, D26, E20, E21, E25, E26, F20, G20, K10, K17, R4, U10, U23, V10, W7, AB21, AC20, AC21, AC22, AC23, AC25, AD26, W20	LFE2M50: G5, G4, K7, K8, E1, F2, F1, G3, G2, G1, L9, L7, K6, K5, L8, L6, AA1, AA2, Y3, AB1, Y9, Y8, Y7, AA7, AB2, AB3, AA5, AA6, AB4, AB5, AA8, AA9, AJ1, AK4, AH6, AH3, AH11, AH8, AK10, AJ13, AB26, AB27, Y24, Y25, AA29, Y28, Y30, Y29, W22, V22, Y27, Y26, W30, W29, W25, W26, L24, L23, D30, D29, K24, K25, J27, K26, J26, H26, H27, G26, H23, H24, D28, E28, J18, J19, H17, J17, F18, F17, B13, A10, C8, C11, C3, C6, A4, B1, AA26, AB11, AB12, AB13, AB14, AB15, AB16, AB17, AB19, AB20, AB21, AC11, AC21, AC22, AD21, AD22, AE23, AF20, AF23, AG23, AG26, F20, F23, G10, G20, G21, H19, H20, H21, H22, J20, J21, R9, U22, W9 LFE2M70/LFE2M100: AA26, AB10, AB11, AB12, AB13, AB14, AB15, AB16, AB17, AB19, AB20, AB21, AB9, AC10, AC11, AC21, AC22, AC8, AC9, AD21, AD22, AD4, AD5, AD6, AD7, AD8, AE23, AE5, AE6, AE7, AF20, AF23, AF5, AG23, AG26, D10, E10, E11, F10, F20, F23, F8, G10, G20, G21, G7, G8, G9, H19, H20, H21, H22, H6, H8, H9, J10, J20, J21, J9, K9, R9, U22, W9

1. All grounds must be electrically connected at the board level. For fpBGA packages, the total number of GND balls is less than the actual number of GND logic connections from the die to the common package GND plane.
2. NC pins should not be connected to any active signals, VCC or GND.
3. For package migration across device densities, the designer must comprehend the package pin requirements for the SERDES blocks. Specifically, the SERDES power pins of the largest density device must be accounted to accommodate migration to other smaller devices using the same package. Please refer to TN1160, [LatticeECP2/M Density Migration](#) for more details.

LFE2-12E/SE and LFE2-20E/SE Logic Signal Connections: 484 fpBGA (Cont.)

LFE2-12E/12SE					LFE2-20E/20SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
H16	NC	-			NC	-		
H20	NC	-			NC	-		
H18	NC	-			NC	-		
K6	NC	-			NC	-		
J16	NC	-			NC	-		
N18	VCC	-			VCC	-		
N6	VCC	-			VCC	-		

* Supports true LVDS. Other differential signals must be emulated with external resistors.

** These dedicated input pins can be used for GPLLs or GDLLs within the respective quadrant.

Note: VCCIO and GND pads are used to determine the average DC current drawn by I/Os between GND/VCCIO connections, or between the last GND/VCCIO in an I/O bank and the end of an I/O bank. The substrate pads listed in the Pin Table do not necessarily have a one to one connection with a package ball or pin.

LFE2-20E/SE and LFE2-35E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2-20E/20SE					LFE2-35E/35SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
GND	GNDIO1	-			GNDIO1	-		
C15	PT45B	1		C	PT45B	1		C
A15	PT45A	1		T	PT45A	1		T
A13	PT44B	1		C	PT44B	1		C
B13	PT44A	1		T	PT44A	1		T
VCCIO	VCCIO1	1			VCCIO1	1		
H17	PT43B	1		C	PT43B	1		C
H15	PT43A	1		T	PT43A	1		T
D13	PT42B	1		C	PT42B	1		C
C14	PT42A	1		T	PT42A	1		T
GND	GNDIO1	-			GNDIO1	-		
G14	PT41B	1		C	PT41B	1		C
E14	PT41A	1		T	PT41A	1		T
A12	PT40B	1		C	PT40B	1		C
B12	PT40A	1		T	PT40A	1		T
VCCIO	VCCIO1	1			VCCIO1	1		
F14	PT39B	1	PCLKC1_0	C	PT39B	1	PCLKC1_0	C
D14	PT39A	1	PCLKT1_0	T	PT39A	1	PCLKT1_0	T
H16	XRES	1			XRES	1		
H14	PT37B	0	PCLKC0_0	C	PT37B	0	PCLKC0_0	C
GND	GNDIO0	-			GNDIO0	-		
H13	PT37A	0	PCLKT0_0	T	PT37A	0	PCLKT0_0	T
A11	PT36B	0		C	PT36B	0		C
B11	PT36A	0		T	PT36A	0		T
C13	PT35B	0		C	PT35B	0		C
VCCIO	VCCIO0	0			VCCIO0	0		
E13	PT35A	0		T	PT35A	0		T
D12	PT34B	0		C	PT34B	0		C
F13	PT34A	0		T	PT34A	0		T
A10	PT33B	0		C	PT33B	0		C
B10	PT33A	0		T	PT33A	0		T
C12	PT32B	0		C	PT32B	0		C
GND	GNDIO0	-			GNDIO0	-		
C10	PT32A	0		T	PT32A	0		T
G13	PT31B	0		C	PT31B	0		C
VCCIO	VCCIO0	0			VCCIO0	0		
H12	PT31A	0		T	PT31A	0		T
A9	PT30B	0		C	PT30B	0		C
B9	PT30A	0		T	PT30A	0		T
E12	PT29B	0		C	PT29B	0		C
G12	PT29A	0		T	PT29A	0		T
A8	PT28B	0		C	PT28B	0		C
B8	PT28A	0		T	PT28A	0		T
GND	GNDIO0	-			GNDIO0	-		
E11	PT27B	0		C	PT27B	0		C
C9	PT27A	0		T	PT27A	0		T

LFE2-20E/SE and LFE2-35E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2-20E/20SE					LFE2-35E/35SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
A7	PT26B	0		C	PT26B	0		C
B7	PT26A	0		T	PT26A	0		T
VCCIO	VCCIO0	0			VCCIO0	0		
F12	PT25B	0		C	PT25B	0		C
D10	PT25A	0		T	PT25A	0		T
H11	PT24B	0		C	PT24B	0		C
G11	PT24A	0		T	PT24A	0		T
GND	GNDIO0	-			GNDIO0	-		
A6	PT23B	0		C	PT23B	0		C
B6	PT23A	0		T	PT23A	0		T
D8	PT22B	0		C	PT22B	0		C
C8	PT22A	0		T	PT22A	0		T
VCCIO	VCCIO0	0			VCCIO0	0		
F11	PT21B	0		C	PT21B	0		C
E10	PT21A	0		T	PT21A	0		T
E9	PT20B	0		C	PT20B	0		C
D9	PT20A	0		T	PT20A	0		T
G10	PT19B	0		C	PT19B	0		C
GND	GNDIO0	-			GNDIO0	-		
H10	PT19A	0		T	PT19A	0		T
A5	PT18B	0		C	PT18B	0		C
B5	PT18A	0		T	PT18A	0		T
C7	PT17B	0		C	PT17B	0		C
VCCIO	VCCIO0	0			VCCIO0	0		
D7	PT17A	0		T	PT17A	0		T
E8	PT16B	0		C	PT16B	0		C
F10	PT16A	0		T	PT16A	0		T
F8	PT15B	0		C	PT15B	0		C
H9	PT15A	0		T	PT15A	0		T
C5	PT14B	0		C	PT14B	0		C
GND	GNDIO0	-			GNDIO0	-		
D5	PT14A	0		T	PT14A	0		T
B4	PT13B	0			PT13B	0		
VCCIO	VCCIO0	0			VCCIO0	0		
GND	GNDIO0	-			GNDIO0	-		
VCCIO	VCCIO0	0			VCCIO0	0		
GND	GNDIO0	-			GNDIO0	-		
VCCIO	VCCIO0	0			VCCIO0	0		
C4	PT10B	0		C	PT10B	0		C
GND	GNDIO0	-			GNDIO0	-		
C3	PT10A	0		T	PT10A	0		T
A4	PT9B	0		C	PT9B	0		C
A3	PT9A	0		T	PT9A	0		T
B3	PT8B	0		C	PT8B	0		C
VCCIO	VCCIO0	0			VCCIO0	0		
B2	PT8A	0		T	PT8A	0		T

LFE2-50E/SE and LFE2-70E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2-50E/SE					LFE2-70E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
N15	GND	-			GND	-		
N17	GND	-			GND	-		
P10	GND	-			GND	-		
P12	GND	-			GND	-		
P13	GND	-			GND	-		
P14	GND	-			GND	-		
P15	GND	-			GND	-		
P17	GND	-			GND	-		
R13	GND	-			GND	-		
R14	GND	-			GND	-		
T10	GND	-			GND	-		
T11	GND	-			GND	-		
T16	GND	-			GND	-		
T17	GND	-			GND	-		
T24	GND	-			GND	-		
T3	GND	-			GND	-		
U10	GND	-			GND	-		
U11	GND	-			GND	-		
U13	GND	-			GND	-		
U14	GND	-			GND	-		
U16	GND	-			GND	-		
U17	GND	-			GND	-		
V13	GND	-			GND	-		
V14	GND	-			GND	-		
V21	GND	-			GND	-		
V6	GND	-			GND	-		
M3	NC	-			NC	-		
N6	NC	-			NC	-		
P24	NC	-			NC	-		

* Supports true LVDS. Other differential signals must be emulated with external resistors.

** These dedicated input pins can be used for GPLLs or GDLLs within the respective quadrant.

***Due to packaging bond out option, this DQS does not have all the necessary DQ pins bonded out for a full 8-bit data width.

Note: VCCIO and GND pads are used to determine the average DC current drawn by I/Os between GND/VCCIO connections, or between the last GND/VCCIO in an I/O bank and the end of an I/O bank. The substrate pads listed in the Pin Table do not necessarily have a one to one connection with a package ball or pin.

LFE2-70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2-70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
AD18	PB66A	4	BDQ69	T
AF18	PB66B	4	BDQ69	C
AC18	PB67A	4	BDQ69	T
AE18	PB67B	4	BDQ69	C
VCCIO	VCCIO4	4		
AG19	PB68A	4	BDQ69	T
AH19	PB68B	4	BDQ69	C
GND	GNDIO4	-		
AE19	PB69A	4	BDQS69	T
AF19	PB69B	4	BDQ69	C
AC19	PB70A	4	BDQ69	T
AD19	PB70B	4	BDQ69	C
AJ19	PB71A	4	BDQ69	T
AK19	PB71B	4	BDQ69	C
VCCIO	VCCIO4	4		
AF20	PB72A	4	BDQ69	T
AH20	PB72B	4	BDQ69	C
AE20	PB73A	4	BDQ69	T
AG20	PB73B	4	BDQ69	C
GND	GNDIO4	-		
AD20	PB74A	4	BDQ78	T
AC20	PB74B	4	BDQ78	C
AH21	PB75A	4	BDQ78	T
AF21	PB75B	4	BDQ78	C
AJ20	PB76A	4	BDQ78	T
VCCIO	VCCIO4	4		
AK20	PB76B	4	BDQ78	C
AG21	PB77A	4	BDQ78	T
AE21	PB77B	4	BDQ78	C
AD21	PB78A	4	BDQS78	T
GND	GNDIO4	-		
AC21	PB78B	4	BDQ78	C
AD22	PB79A	4	BDQ78	T
AB21	PB79B	4	BDQ78	C
AJ21	PB80A	4	BDQ78	T
VCCIO	VCCIO4	4		
AK21	PB80B	4	BDQ78	C
GND	GNDIO4	-		
VCCIO	VCCIO4	4		
AJ25	PB87A	4	BDQS87***	T
AK24	PB87B	4	BDQ87	C
AJ24	PB88A	4	BDQ87	T
AK25	PB88B	4	BDQ87	C

LFE2M-20E/SE and LFE2M-35E/SE Logic Signal Connections: 256 fpBGA (Cont.)

LFE2M20E/SE					LFE2M35E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
A7	URC_SQ_HDOUTP3	12		T	URC_SQ_HDOUTP3	12		T
C6	URC_SQ_VCCTX3	12			URC_SQ_VCCTX3	12		
B4	URC_SQ_HDINN3	12		C	URC_SQ_HDINN3	12		C
B3	URC_SQ_VCCIB3	12			URC_SQ_VCCIB3	12		
A4	URC_SQ_HDINP3	12		T	URC_SQ_HDINP3	12		T
C3	URC_SQ_VCCRX3	12			URC_SQ_VCCRX3	12		
GNDIO	GNDIO1	-			GNDIO1	-		
VCCIO	VCCIO1	1			VCCIO1	1		
GNDIO	GNDIO0	-			GNDIO0	-		
VCCIO	VCCIO0	0			VCCIO0	0		
G10	VCCPLL	-			VCCPLL	-		
G7	VCC	-			VCC	-		
G9	VCC	-			VCC	-		
H7	VCC	-			VCC	-		
J10	VCC	-			VCC	-		
K10	VCC	-			VCC	-		
K8	VCC	-			VCC	-		
E7	VCCIO0	0			VCCIO0	0		
VCCIO	VCCIO0	0			VCCIO0	0		
E10	VCCIO1	1			VCCIO1	1		
VCCIO	VCCIO1	1			VCCIO1	1		
E14	VCCIO2	2			VCCIO2	2		
G12	VCCIO2	2			VCCIO2	2		
VCCIO	VCCIO2	2			VCCIO2	2		
K12	VCCIO3	3			VCCIO3	3		
M14	VCCIO3	3			VCCIO3	3		
VCCIO	VCCIO3	3			VCCIO3	3		
M10	VCCIO4	4			VCCIO4	4		
P12	VCCIO4	4			VCCIO4	4		
VCCIO	VCCIO4	4			VCCIO4	4		
M7	VCCIO5	5			VCCIO5	5		
P5	VCCIO5	5			VCCIO5	5		
VCCIO	VCCIO5	5			VCCIO5	5		
K5	VCCIO6	6			VCCIO6	6		
M3	VCCIO6	6			VCCIO6	6		
VCCIO	VCCIO6	6			VCCIO6	6		
E3	VCCIO7	7			VCCIO7	7		
G5	VCCIO7	7			VCCIO7	7		
VCCIO	VCCIO7	7			VCCIO7	7		
T15	VCCIO8	8			VCCIO8	8		
VCCIO	VCCIO8	8			VCCIO8	8		
G8	VCCAUX	-			VCCAUX	-		
H10	VCCAUX	-			VCCAUX	-		
J7	VCCAUX	-			VCCAUX	-		
K9	VCCAUX	-			VCCAUX	-		
A1	GND	-			GND	-		
A15	GND	-			GND	-		
A16	GND	-			GND	-		

LFE2M50E/SE Logic Signal Connections: 484 fpBGA (Cont.)

LFE2M50E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
Y6	PB8A	5	BDQ6	T
Y5	PB8B	5	BDQ6	C
VCCIO	VCCIO5	5		
AB3	PB9A	5	BDQ6	T
AB4	PB9B	5	BDQ6	C
AB5	PB10A	5	BDQ6	T
AA6	PB10B	5	BDQ6	C
GNDIO	GNDIO5	-		
VCCIO	VCCIO5	5		
V9	PB40A	5	BDQ42	T
U9	PB40B	5	BDQ42	C
VCCIO	VCCIO5	5		
U10	PB41A	5	BDQ42	T
T10	PB41B	5	BDQ42	C
GNDIO	GNDIO5	-		
W9	PB42A	5	BDQS42****	T
Y8	PB42B	5	BDQ42	C
AA7	PB43A	5	VREF2_5/BDQ42	T
Y7	PB43B	5	VREF1_5/BDQ42	C
AB6	PB44A	5	PCLKT5_0/BDQ42	T
AB7	PB44B	5	PCLKC5_0/BDQ42	C
VCCIO	VCCIO5	5		
GNDIO	GNDIO5	-		
AA8	PB49A	4	PCLKT4_0/BDQ51	T
VCCIO	VCCIO4	4		
AB8	PB49B	4	PCLKC4_0/BDQ51	C
AA9	PB50A	4	VREF2_4/BDQ51	T
Y9	PB50B	4	VREF1_4/BDQ51	C
AB9	PB51A	4	BDQS51****	T
GNDIO	GNDIO4	-		
AB10	PB51B	4	BDQ51	C
AA10	PB52A	4	BDQ51	T
Y11	PB52B	4	BDQ51	C
VCCIO	VCCIO4	4		
GNDIO	GNDIO4	-		
V10	PB56A	4	BDQ60	T
U11	PB56B	4	BDQ60	C
V11	PB57A	4	BDQ60	T
W11	PB57B	4	BDQ60	C
AA11	PB58A	4	BDQ60	T
AB11	PB58B	4	BDQ60	C
VCCIO	VCCIO4	4		
T11	PB59A	4	BDQ60	T

LFE2M35E/SE and LFE2M50E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2M35E/SE					LFE2M50E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
C15	URC_SQ_VCCIB2	12			URC_SQ_VCCIB2	12			
B15	URC_SQ_HDINN2	12		C	URC_SQ_HDINN2	12		C	
C14	URC_SQ_VCCRX2	12			URC_SQ_VCCRX2	12			
A18	URC_SQ_HDOUTP2	12		T	URC_SQ_HDOUTP2	12		T	
C18	URC_SQ_VCCOB2	12			URC_SQ_VCCOB2	12			
B18	URC_SQ_HDOUTN2	12		C	URC_SQ_HDOUTN2	12		C	
C17	URC_SQ_VCCTX2	12			URC_SQ_VCCTX2	12			
B17	URC_SQ_HDOUTN3	12		C	URC_SQ_HDOUTN3	12		C	
A16	URC_SQ_VCCOB3	12			URC_SQ_VCCOB3	12			
A17	URC_SQ_HDOUTP3	12		T	URC_SQ_HDOUTP3	12		T	
C16	URC_SQ_VCCTX3	12			URC_SQ_VCCTX3	12			
B14	URC_SQ_HDINN3	12		C	URC_SQ_HDINN3	12		C	
B13	URC_SQ_VCCIB3	12			URC_SQ_VCCIB3	12			
A14	URC_SQ_HDINP3	12		T	URC_SQ_HDINP3	12		T	
C13	URC_SQ_VCCRX3	12			URC_SQ_VCCRX3	12			
-	-	-			GNDIO1	-			
-	-	-			VCCIO1	1			
E17	PT46B	1		C	PT55B	1		C	
D17	PT46A	1		T	PT55A	1		T	
GNDIO	GNDIO1	-			GNDIO1	-			
F17	PT45B	1		C	PT54B	1		C	
D16	PT45A	1		T	PT54A	1		T	
F19	PT44B	1		C	PT53B	1		C	
F18	PT44A	1		T	PT53A	1		T	
VCCIO	VCCIO1	1			VCCIO1	1			
E16	PT43B	1		C	PT52B	1		C	
D15	PT43A	1		T	PT52A	1		T	
G18	PT42B	1		C	PT51B	1		C	
E15	PT42A	1		T	PT51A	1		T	
GNDIO	GNDIO1	-			GNDIO1	-			
G17	PT41B	1		C	PT50B	1		C	
E14	PT41A	1		T	PT50A	1		T	
D14	PT40B	1		C	PT49B	1		C	
D13	PT40A	1		T	PT49A	1		T	
VCCIO	VCCIO1	1			VCCIO1	1			
F15	PT39B	1	VREF2_1	C	PT48B	1	VREF2_1	C	
E12	PT39A	1	VREF1_1	T	PT48A	1	VREF1_1	T	
H17	PT38B	1	PCLKC1_0	C	PT47B	1	PCLKC1_0	C	
E13	PT38A	1	PCLKT1_0	T	PT47A	1	PCLKT1_0	T	
C12	PT37B	0	PCLKC0_0	C	PT46B	0	PCLKC0_0	C	
GNDIO	GNDIO0	-			GNDIO0	-			
G15	PT37A	0	PCLKT0_0	T	PT46A	0	PCLKT0_0	T	
C11	PT36B	0	VREF2_0	C	PT45B	0	VREF2_0	C	
F14	PT36A	0	VREF1_0	T	PT45A	0	VREF1_0	T	

LFE2M100E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
M10	VCCIO7	7		
M7	VCCIO7	7		
N10	VCCIO7	7		
N3	VCCIO7	7		
P10	VCCIO7	7		
R6	VCCIO7	7		
AA25	VCCIO8	8		
AD28	VCCIO8	8		
AA10	VCCAUX	-		
AA11	VCCAUX	-		
AA20	VCCAUX	-		
AA21	VCCAUX	-		
K10	VCCAUX	-		
K11	VCCAUX	-		
K20	VCCAUX	-		
K21	VCCAUX	-		
L10	VCCAUX	-		
L11	VCCAUX	-		
L20	VCCAUX	-		
L21	VCCAUX	-		
Y10	VCCAUX	-		
Y11	VCCAUX	-		
Y20	VCCAUX	-		
Y21	VCCAUX	-		
A1	GND	-		
A13	GND	-		
A18	GND	-		
A24	GND	-		
A30	GND	-		
A7	GND	-		
AA14	GND	-		
AA15	GND	-		
AA16	GND	-		
AA17	GND	-		
AA24	GND	-		
AA27	GND	-		
AA4	GND	-		
AB24	GND	-		
AB7	GND	-		
AD12	GND	-		
AD19	GND	-		
AD27	GND	-		
AE22	GND	-		

LFE2M70E/SE and LFE2M100E/SE Logic Signal Connections: 1152 fpBGA (Cont.)

LFE2M70E/SE				LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
E5	ULC_SQ_REFCLKN	11		C	ULC_SQ_REFCLKN	11		C
D5	ULC_SQ_REFCLKP	11		T	ULC_SQ_REFCLKP	11		T
D6	ULC_SQ_VCCP	11			ULC_SQ_VCCP	11		
C5	ULC_SQ_HDINP2	11		T	ULC_SQ_HDINP2	11		T
D4	ULC_SQ_VCCIB2	11			ULC_SQ_VCCIB2	11		
C4	ULC_SQ_HDINN2	11		C	ULC_SQ_HDINN2	11		C
B5	ULC_SQ_VCCRX2	11			ULC_SQ_VCCRX2	11		
A5	ULC_SQ_HDOUTP2	11		T	ULC_SQ_HDOUTP2	11		T
D3	ULC_SQ_VCCOB2	11			ULC_SQ_VCCOB2	11		
A4	ULC_SQ_HDOUTN2	11		C	ULC_SQ_HDOUTN2	11		C
B4	ULC_SQ_VCCTX2	11			ULC_SQ_VCCTX2	11		
A3	ULC_SQ_HDOUTN3	11		C	ULC_SQ_HDOUTN3	11		C
C1	ULC_SQ_VCCOB3	11			ULC_SQ_VCCOB3	11		
A2	ULC_SQ_HDOUTP3	11		T	ULC_SQ_HDOUTP3	11		T
B3	ULC_SQ_VCCTX3	11			ULC_SQ_VCCTX3	11		
C3	ULC_SQ_HDINN3	11		C	ULC_SQ_HDINN3	11		C
B1	ULC_SQ_VCCIB3	11			ULC_SQ_VCCIB3	11		
C2	ULC_SQ_HDINP3	11		T	ULC_SQ_HDINP3	11		T
B2	ULC_SQ_VCCRX3	11			ULC_SQ_VCCRX3	11		
AA13	VCC	-			VCC	-		
AA14	VCC	-			VCC	-		
AA15	VCC	-			VCC	-		
AA16	VCC	-			VCC	-		
AA17	VCC	-			VCC	-		
AA18	VCC	-			VCC	-		
AA19	VCC	-			VCC	-		
AA20	VCC	-			VCC	-		
AA21	VCC	-			VCC	-		
AA22	VCC	-			VCC	-		
AB14	VCC	-			VCC	-		
AB15	VCC	-			VCC	-		
AB20	VCC	-			VCC	-		
AB21	VCC	-			VCC	-		
N14	VCC	-			VCC	-		
N15	VCC	-			VCC	-		
N20	VCC	-			VCC	-		
N21	VCC	-			VCC	-		
P13	VCC	-			VCC	-		
P14	VCC	-			VCC	-		
P15	VCC	-			VCC	-		
P16	VCC	-			VCC	-		
P17	VCC	-			VCC	-		
P18	VCC	-			VCC	-		
P19	VCC	-			VCC	-		
P20	VCC	-			VCC	-		
P21	VCC	-			VCC	-		
P22	VCC	-			VCC	-		
R13	VCC	-			VCC	-		
R14	VCC	-			VCC	-		

LFE2M70E/SE and LFE2M100E/SE Logic Signal Connections: 1152 fpBGA (Cont.)

LFE2M70E/SE				LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
K11	NC	-			NC	-		
K12	NC	-			NC	-		
K13	NC	-			NC	-		
K23	NC	-			NC	-		
K24	NC	-			NC	-		
K25	NC	-			NC	-		
K26	NC	-			NC	-		
L11	NC	-			NC	-		
L12	NC	-			NC	-		
L13	NC	-			NC	-		
L14	NC	-			NC	-		
L21	NC	-			NC	-		
L22	NC	-			NC	-		
L23	NC	-			NC	-		
L24	NC	-			NC	-		
L25	NC	-			NC	-		
L26	NC	-			NC	-		
M11	NC	-			NC	-		
M24	NC	-			NC	-		
M25	NC	-			NC	-		
M6	NC	-			NC	-		
M8	NC	-			NC	-		
N10	NC	-			NC	-		
N11	NC	-			NC	-		
P10	NC	-			NC	-		
P25	NC	-			NC	-		
P26	NC	-			NC	-		
R9	NC	-			NC	-		
T11	NC	-			NC	-		
U11	NC	-			NC	-		
W11	NC	-			NC	-		
Y10	NC	-			NC	-		
Y11	NC	-			NC	-		
R15	VCCPLL	-			VCCPLL	-		
R20	VCCPLL	-			VCCPLL	-		
Y15	VCCPLL	-			VCCPLL	-		
Y20	VCCPLL	-			VCCPLL	-		

* Supports true LVDS. Other differential signals must be emulated with external resistors.

** These dedicated input pins can be used for GPLLs or GDLLs within the respective quadrant.

*** For density migration, board design must take into account that these sysCONFIG pins are dual function for the lower density devices (ECP2M20 and ECP2M35). They can be either sysCONFIG pins or general purpose I/Os. These pins are dedicated pins for the higher density devices (ECP2M50, ECP2M70, and ECP2M100).

****Due to packaging bond out option, this DQS does not have all the necessary DQ pins bonded out for a full 8-bit data width.

Note: VCCIO and GND pads are used to determine the average DC current drawn by I/Os between GND/VCCIO connections, or between the last GND/VCCIO in an I/O bank and the end of an I/O bank. The substrate pads listed in the Pin Table do not necessarily have a one to one connection with a package ball or pin.

LatticeECP2 Standard Series Devices, Conventional Packaging
Commercial

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-6E-5T144C	90	1.2V	-5	TQFP	144	COM	6
LFE2-6E-6T144C	90	1.2V	-6	TQFP	144	COM	6
LFE2-6E-7T144C	90	1.2V	-7	TQFP	144	COM	6
LFE2-6E-5F256C	190	1.2V	-5	fpBGA	256	COM	6
LFE2-6E-6F256C	190	1.2V	-6	fpBGA	256	COM	6
LFE2-6E-7F256C	190	1.2V	-7	fpBGA	256	COM	6

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-12E-5T144C	93	1.2V	-5	TQFP	144	COM	12
LFE2-12E-6T144C	93	1.2V	-6	TQFP	144	COM	12
LFE2-12E-7T144C	93	1.2V	-7	TQFP	144	COM	12
LFE2-12E-5Q208C	131	1.2V	-5	PQFP	208	COM	12
LFE2-12E-6Q208C	131	1.2V	-6	PQFP	208	COM	12
LFE2-12E-7Q208C	131	1.2V	-7	PQFP	208	COM	12
LFE2-12E-5F256C	193	1.2V	-5	fpBGA	256	COM	12
LFE2-12E-6F256C	193	1.2V	-6	fpBGA	256	COM	12
LFE2-12E-7F256C	193	1.2V	-7	fpBGA	256	COM	12
LFE2-12E-5F484C	297	1.2V	-5	fpBGA	484	COM	12
LFE2-12E-6F484C	297	1.2V	-6	fpBGA	484	COM	12
LFE2-12E-7F484C	297	1.2V	-7	fpBGA	484	COM	12

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-20E-5Q208C	131	1.2V	-5	PQFP	208	COM	20
LFE2-20E-6Q208C	131	1.2V	-6	PQFP	208	COM	20
LFE2-20E-7Q208C	131	1.2V	-7	PQFP	208	COM	20
LFE2-20E-5F256C	193	1.2V	-5	fpBGA	256	COM	20
LFE2-20E-6F256C	193	1.2V	-6	fpBGA	256	COM	20
LFE2-20E-7F256C	193	1.2V	-7	fpBGA	256	COM	20
LFE2-20E-5F484C	331	1.2V	-5	fpBGA	484	COM	20
LFE2-20E-6F484C	331	1.2V	-6	fpBGA	484	COM	20
LFE2-20E-7F484C	331	1.2V	-7	fpBGA	484	COM	20
LFE2-20E-5F672C	402	1.2V	-5	fpBGA	672	COM	20
LFE2-20E-6F672C	402	1.2V	-6	fpBGA	672	COM	20
LFE2-20E-7F672C	402	1.2V	-7	fpBGA	672	COM	20